Docket No.: 240416US0DIV/hyc

## IN THE UNITED STATES AND TRADEMARK OFFICE

IN RE APPLICATION OF: Masakazu KANECHIKA, et al.

<u></u>

SERIAL NUMBER: 10/618,085

**GROUP: 2813** 

FILED: July 14, 2003

**EXAMINER: Tuan H. NGUYEN** 

FOR: METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE AND

SEMICONDUCTOR DEVICE

## REQUEST FOR PRIORITY ACKNOWLEDGMENT UNDER 35 U.S.C. 119 AND THE INTERNATIONAL CONVENTION

MAIL STOP ISSUE FEE COMMISSIONER FOR PATENTS P.O. BOX 1450 **ALEXANDRIA, VA 22313-1450** 

SIR:

In the matter of the above-identified application for patent, notice is hereby given that the Applicant(s) claim as priority:

Country	Application No.	Month/Day/Year
Japan	10-313976	October 16, 1998
Japan	11-092855	March 31, 1999
Japan	11-172024	June 18, 1999
Japan	11-242883	August 30, 1999

A Certified copy of the corresponding Convention Application was filed in Serial

Number 09/420,524, filed October 18, 1999, of which this application is a Divisional.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.

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